TOSHIBA Photocoupler Photorelay

TLP172G

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Modem·Fax Cards, Modems in PC Telecommunications
PBX

Measurement Equipment

The Toshiba TLP172G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

The TLP172G is suitable for the modem applications which require space savings. $\,$

• 4-pin SOP (2.54SOP4): Height = 2.1 mm, Pitch = 2.54 mm

• 1-Form-A

• Trigger LED current: 3 mA (max)

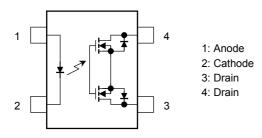
• On-state current: 110 mA (max)

• On-state resistance: 35Ω (max t < 1 s)

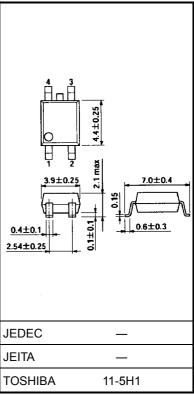
• On-state resistance: 50Ω (max continuous)

• Isolation voltage: 1500 Vrms (min)

Pin Configuration (top view)



Unit: mm



Weight: 0.1 g (typ.)

Maximum Rating (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
	Forward current	l _F	50	mA	
	Forward current derating (Ta ≧ 25°C)	ΔI _F /°C	-0.5	mA/°C	
LED	Reverse voltage	V_{R}	5	٧	
	Junction temperature	Tj	125	°C	
	Off-state output terminal voltage	V _{OFF}	350	V	
	On-state current	I _{ON}	110	mA	
Detector	On-state current derating (Ta ≧ 25°C)	Δl _{ON} /°C	-1.1	mA/°C	
	Junction temperature	Tj	125	°C	
Storage temperature range		T _{stg}	-55~125	°C	
Operating temperature range		T _{opr}	-40~85	°C	
Lead soldering temperature (10 s)		T _{sol}	260	°C	
Isolation voltage (AC, 1 min, R.H. ≦ 60%) (Note 1)		BVS	1500	Vrms	

Note 1: Device considered a two-terminal device: LED side pins shorted together, and detector side pins shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V_{DD}			280	٧
Forward current	I _F	5	7.5	25	mA
On-state current	I _{ON}	_	_	100	mA
Operating temperature	T _{opr}	-20	_	65	°C

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance	C _T	V = 0, f = 1 MHz	_	30	_	pF
Detector	Off-state current	l _{OFF}	V _{OFF} = 350 V	_	_	1	μΑ
Detector	Capacitance	C _{OFF}	V = 0, f = 1 MHz	_	30	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	I _{ON} = 110 mA	_	1	3	mA
Return LED current	I _{FC}	I _{OFF} = 100 μA	0.1		_	mA
On-state resistance	R _{ON}	$I_{ON} = 110 \text{ mA}, I_{F} = 5 \text{ mA}, t < 1 \text{ s}$	_	25	35	Ω
	TON	$I_{ON} = 110 \text{ mA}, I_F = 5 \text{ mA}, \text{ continuous}$		35	50	22

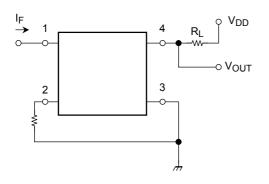
Isolation Characteristics (Ta = 25°C)

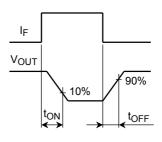
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≦ 60%	5×10^{10}	10 ¹⁴	_	Ω
		AC, 1 min	1500	_	_	Vrms
Isolation voltage	BV_S	AC, 1 s, in oil 3000	3000	_	VIIIIS	
		DC, 1 min, in oil	_	3000	_	Vdc

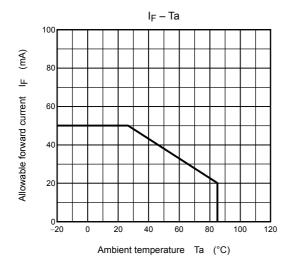
Switching Characteristics (Ta = 25°C)

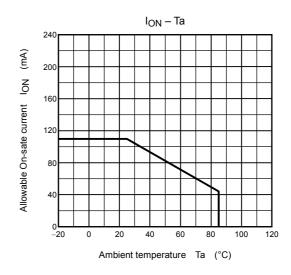
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}	$R_L = 200 \Omega$	_	0.3	1	ms
Turn-off time	toff	$V_{DD} = 20 \text{ V}, I_F = 5 \text{ mA}$ (Note 2)	_	0.1	1	1113

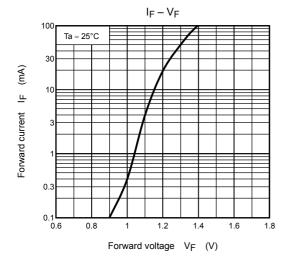
Note 2: Switching time test circuit

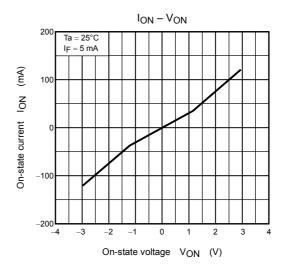


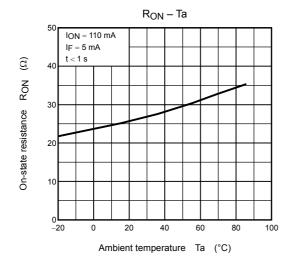


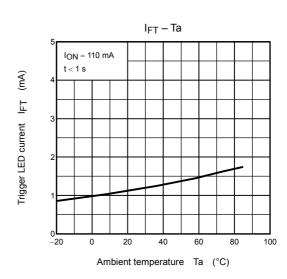


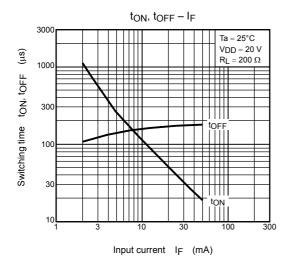


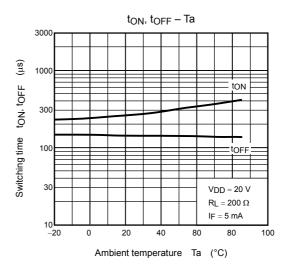


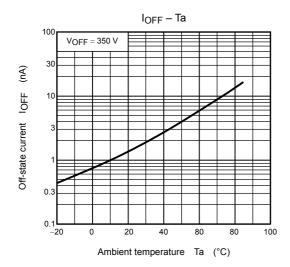












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